

Law of Mass Action: Charge Carriers in Semiconductors

- a) Calculate the intrinsic carrier concentration of silicon at 300 K. What fraction of silicon atoms donates electrons and holes at 300 K? The mass density of silicon is $\rho_{\text{Si}} = 2.328 \text{ g/cm}^3$, quantum density of silicon at 300 K is $n_q = 1.2 \times 10^{25} \text{ m}^{-3}$, and the bandgap is $\Delta = 1.12 \text{ eV}$.

$$n_i = n_q \exp\left[-\frac{\Delta}{(2kT)}\right] = (1.2 \times 10^{25}) \exp\left[-\frac{1.12}{(2 * 0.026)}\right]$$

$$= 5.3 \times 10^{15} / \text{m}^3$$

We also calculate the concentration of silicon atoms from the mass density giving $5 \times 10^{19} / \text{m}^3$

This gives us a fraction of 10^{-4} .

- b) If we raise the temperature to 310 K, by what factor do we change the intrinsic carrier density?

Plugging into the formula for n_i we get $10.6 \times 10^{15} / \text{m}^3$

This changes by a factor of approximately 2.

- c) If instead we wanted the same density of free electrons at 300 K as we have at 310 K, what fraction of silicon atoms need to be replaced with a donor impurity, e.g., phosphorous? In this problem, we want to dope silicon such that the density of electrons at 300 K equals the intrinsic density of electrons at 310 K.

We need $10.6 \times 10^{15} / \text{m}^3$ electrons. Therefore we need $10.6 \times 10^{15} - 5.3 \times 10^{15} / \text{m}^3$ electrons. Therefore, we have a fraction of 10^{-4} silicon atoms needing to be replaced.

- d) With this many donors, what is the new density of holes in the doped semiconductor?

Here we can use the law of mass action: $n_e n_h = n_i^2$.

We have that $n_e = 10.6 \times 10^{15} / \text{m}^3$ and (from part a) that $n_i = 5.3 \times 10^{15} / \text{m}^3$. Therefore, $n_h = 2.65 \times 10^{15} / \text{m}^3$.